



Application No.: 09/245,269

Docket No.: INTECH 3.0-038
99P7451US

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Dated: October 14, 2002

Signature: *Lawrence E. Russ*

(Lawrence E. Russ)

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REPLY UNDER 37 CFR 1.116
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Docket No.: INTECH 3.0-038
99P7451US
(PATENT)

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10-24-02
J. Antea

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
J. Mandelman et al.

Application No.: 09/245,269

Group Art Unit: 2814

Filed: February 5, 1999

Examiner: D. Nguyen

For: FIELD-SHIELD-TRENCH ISOLATION FOR
GIGABIT DRAMS

Box AF
Commissioner for Patents
Washington, DC 20231

AMENDMENT UNDER 37 CFR 1.116

Dear Sir:

In response to the Final Office Action dated July 15, 2001, Applicants submit the following amendments and remarks:

IN THE CLAIMS:

Cancel claims 3-20.

REMARKS

Reconsideration and allowance of this application is respectfully requested. Claims 3-20 are withdrawn. Claims 1-2 remain in this application and are submitted for the Examiner's consideration.

In the Office Action, the Examiner rejected claims 1-2 under 35 U.S.C. § 112, first paragraph. Specifically, the Examiner asserts: "In claim 1, the phrase 'an isolation trench enclosing an area of the semiconductor body' is not understood and not described in the